

VERSION WITH MARKINGS TO SHOW CHANGES MADE

IN THE SPECIFICATION

The following new paragraph is added on page 5 beginning at line 18.

In one embodiment, daughter-card support 202 provides one or more electrical connections 117 for connecting with electrical connection(s) 115 on motherboard 106. In another embodiment, daughter-card support 202 incorporates a number of holes (exemplified by air flow hole 111) and an air flow channel 113 providing cooling for daughter-card substrate 104, as needed.

IN THE CLAIMS

Claim 14 has been canceled.

Claims 13 and 19 have been amended as follows:

13. (Once Amended) An assembled substrate, comprising:
a motherboard substrate, including one or more electrical components;

one or more daughter-card [substrates] printed circuit boards, wherein at least one of said daughter-card [substrates] printed circuit boards includes one or more electrical components; and

a daughter-card support to structurally support said one or more daughter-card [substrates] printed circuit boards in fixed orientations relative to said motherboard substrate, said daughter-card support supplying structural rigidity to a daughter-card printed circuit board with said daughter-card printed circuit board inserted into said daughter-card support.

19. (Once Amended) The assembled substrate of claim 13, wherein said daughter-card support allows hand replacement of one or more daughter-card [substrates] printed circuit boards.